## Preliminary Technical Data

## FEATURES


SFDR = 85 dBc to $\mathbf{7 0} \mathbf{~ M H z ~ @ ~} 150$ MSPS
Low Power: $\mathbf{7 8 0} \mathbf{~ m W}$
1.8 V analog supply operation
1.8 V to 3.3 V CMOS output supply or 1.8 V LVDS supply

Integer 1 to 8 Input Clock Divider
IF sampling frequencies to $450 \mathbf{M H z}$
Internal ADC voltage reference
Integrated ADC sample-and-hold inputs
Flexible analog input: 1 V p-p to 2 V p-p range
Differential analog inputs with 650MHz bandwidth
ADC clock duty cycle stabilizer
95 dB channel isolation/crosstalk
Serial Port Control
User-configurable built-in self-test (BIST) capability
Energy-saving power-down modes
Integrated Receive Features:
Fast Detect/Threshold Bits
Composite Signal monitor

## APPLICATIONS

## Communications <br> Diversity radio systems

Multimode digital receivers:
GSM, EDGE, PHS, UMTS, WCDMA, CDMA-ONE,
IS95, CDMA2000, IMT-2000, WiMax
I/Q demodulation systems
Smart antenna systems
General-purpose software radios
Broadband data applications

FUNCTIONAL BLOCK DIAGRAM


Figure 1. AD9627 Functional Block Diagram
Rev. PrA
Information furnished by Analog Devices is believed to be accurate and reliable.

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## GENERAL DESCRIPTION

The AD9627 is a dual 12-Bit 150 MSPS ADC. The AD9627 is designed to support communications applications where low cost, small size, and versatility are desired.

The dual ADC core features a multistage differential pipelined architecture with integrated output error correction logic. Each ADC features wide bandwidth differential sample-and-hold analog input amplifiers supporting a variety of user-selectable input ranges. An integrated voltage reference eases design considerations. A duty cycle stabilizer is provided to compensate for variations in the ADC clock duty cycle, allowing the converters to maintain excellent performance.

The AD9627 has several functions which simply the AGC function in the system receiver. The fast detect feature allows fast overrange detection by outputting 4 bits of input level information with very short latency. Additionally, the programmable threshold detector allows monitoring of the incoming signal power from the ADC's 4 fast detect bits with very low latency. If the input signal level exceeds the programmable threshold, the decrement gain indicator will go high. Because this threshold is set from the 4 MSB's this allows the user to quickly turn down the system gain to avoid an overrange condition. The second AGC related function is the Signal monitor. This block allows the user to monitor the composite magnitude of the incoming signal which aids in setting the gain to optimize the dynamic range of the overall system.

The ADC output data can be routed directly to the two external

12-bit output ports. These outputs can be set from 1.8 V to 3.3V CMOS. Or 1.8V LVDS.

Flexible power-down options allow significant power savings, when desired.

## PRODUCT HIGHLIGHTS

- Integrated dual 12-Bit 150 MSPS ADC.
- Fast Over-range Detect and Signal monitor with Serial Output
- Signal monitor block with dedicate serial output mode.
- Proprietary, differential input maintains excellent SNR performance for input frequencies up to 450 MHz .
- The AD9627 operates from a single 1.8 Volt supply and features a separate digital output driver supply to accommodate 1.8 V to 3.3 V logic families.
- A standard serial port interface supports various product features and functions, such as data formatting (offset binary, twos complement, or gray coding), enabling the clock DCS, power-down, and voltage reference mode.
- The AD9627 is pin compatible with the AD9640, allowing a simple migration from 12 to 14 Bits.


## SPECIFICATIONS

## ADC DC SPECIFICATIONS

$\mathrm{AVDD}=1.8 \mathrm{~V}, \mathrm{DVDD}=1.8 \mathrm{~V}, \mathrm{DRVDD}=1.8 \mathrm{~V}$, maximum sample rate, $\mathrm{VIN}=-1.0 \mathrm{dBFS}$ differential input, 1.0 V internal reference, DCS enabled, Fast Detect Outputs disabled, Signal Monitor disabled, unless otherwise noted.
Table 1.


[^0]
## ADC AC SPECIFICATIONS

AVDD $=1.8 \mathrm{~V}, \mathrm{DVDD}=1.8 \mathrm{~V}, \mathrm{DRVDD}=1.8 \mathrm{~V}$, maximum sample rate, $\mathrm{VIN}=-1.0 \mathrm{dBFS}$ differential input, 1.0 V internal reference, DCS Enabled, Fast Detect Outputs disabled, Signal Monitor disabled, unless otherwise noted.
Table 2.

|  |  | AD9627BCPZ-80 |  |  | AD9627BCPZ-105 |  |  | AD9627BCPZ-125 |  |  | AD9627BCPZ-150 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Temp | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| SIGNAL-TO-NOISE-RATIO (SNR) $f_{\mathrm{IN}}=2.4 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 69.5 |  |  | 69.5 |  |  | 69.5 |  |  | 69.5 |  | dB |
|  | Full |  |  |  |  |  |  |  |  |  |  |  |  | dB |
| $\mathrm{fiN}_{\text {N }}=70 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 69.5 |  |  | 69.5 |  |  | 69.5 |  |  | 69.5 |  | dB |
|  | Full | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  |  | dB |
| $\mathrm{fiN}_{\text {I }}=100 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 69.4 |  |  | 69.4 |  |  | 69.4 |  |  | 69.4 |  | dB |
| $\mathrm{fiN}_{\text {I }}=170 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 68.9 |  |  | 68.9 |  |  | 68.9 |  |  | 68.9 |  | dB |
| SIGNAL-TO-NOISE-AND DISTORTION (SINAD) |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{fiN}_{\text {}}=2.4 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 69.2 |  |  | 69.2 |  |  | 69.2 |  |  | 69.2 |  | dB |
|  | Full |  |  |  |  |  |  |  |  |  |  |  |  | dB |
| $\mathrm{fiN}=70 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 69.2 |  |  | 69.2 |  |  | 69.2 |  |  | 69.2 |  | dB |
|  | Full | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  |  | dB |
| $\mathrm{fiN}_{\text {I }}=100 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 69.1 |  |  | 69.1 |  |  | 69.1 |  |  | 69.1 |  | dB |
| $\mathrm{fiN}_{\mathrm{iN}}=170 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 68.6 |  |  | 68.6 |  |  | 68.6 |  |  | 68.6 |  | dB |
| EFFECTIVE NUMBER OF BITS (ENOB) |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{fin}^{\text {}}=2.4 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 11.4 |  |  | 11.4 |  |  | 11.4 |  |  | 11.4 |  | Bits |
| $\mathrm{fix}_{\text {I }}=70 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 11.4 |  |  | 11.4 |  |  | 11.4 |  |  | 11.4 |  | Bits |
| $\mathrm{fiN}_{\mathrm{N}}=100 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 11.4 |  |  | 11.4 |  |  | 11.4 |  |  | 11.4 |  | Bits |
| $\mathrm{ff}_{\mathrm{IN}}=170 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 11.3 |  |  | 11.3 |  |  | 11.3 |  |  | 11.3 |  | Bits |
| WORST SECOND OR THIRD HARMONIC |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{fiN}_{\text {I }}=2.4 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 90 |  |  | 90 |  |  | 90 |  |  | 90 |  | dBC |
|  | Full |  |  |  |  |  |  |  |  |  |  |  |  | dBC |
| $\mathrm{fiN}=70 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 85 |  |  | 85 |  |  | 85 |  |  | 85 |  | dBC |
|  | Full |  |  |  |  |  |  |  |  |  |  |  |  | dBc |
|  | $25^{\circ} \mathrm{C}$ |  | 85 |  |  | $85$ |  |  | $85$ |  |  |  |  | $\mathrm{dBc}$ |
| $f_{\mathrm{IN}}=170 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 83.5 |  |  |  |  |  |  |  |  |  |  |  |
| SPURIOUS-FREE DYNAMIC RANGE (SFDR) |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{fiN}_{\mathrm{N}}=2.4 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 90 |  |  | 90 |  |  | 90 |  |  | 90 |  | dBC |
|  | Full |  |  |  |  |  |  |  |  |  |  |  |  | dBC |
| $\mathrm{fiN}=70 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 85 |  |  | 85 |  |  | 85 |  |  | 85 |  | dBc |
|  | Full |  |  |  |  |  |  |  |  |  |  |  |  | dBC |
| $\mathrm{ff}_{\mathrm{IN}}=100 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 85 |  |  | 85 |  |  | 85 |  |  | 83 |  | dBC |
| $\mathrm{fiN}_{\text {I }}=170 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 84 |  |  | 83.4 |  |  | 83 |  |  | 80 |  | dBC |
| TWO TONE SFDR |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{f}_{\mathrm{N}}=30 \mathrm{MHz}, 31 \mathrm{MHz}(-7 \mathrm{dBFS})$ | $25^{\circ} \mathrm{C}$ |  | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  | dBC |
| $\begin{aligned} & \mathrm{f}_{\mathrm{iN}}=170 \mathrm{MHz}, 171 \mathrm{MHz}(-7 \\ & \mathrm{dBFS}) \end{aligned}$ | $25^{\circ} \mathrm{C}$ |  | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  | dBc |
| CROSSTALK | Full |  | 95 |  |  | 95 |  |  | 95 |  |  | 95 |  | dB |
| ANALOG INPUT BANDWIDTH | $25^{\circ} \mathrm{C}$ |  | 650 |  |  | 650 |  |  | 650 |  |  | 650 |  | MHz |
| MATCHING CHARACTERISTIC |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Offset Error | $25^{\circ} \mathrm{C}$ |  | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  | \%FSR |
| Gain Error | $25^{\circ} \mathrm{C}$ |  | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  | \%FSR |

[^1]
## DIGITAL SPECIFICATIONS

$\mathrm{AVDD}=1.8 \mathrm{~V}, \mathrm{DVDD}=1.8 \mathrm{~V}, \mathrm{DRVDD}=1.8 \mathrm{~V}$, maximum sample rate, -1.0 dBFS differential input, 1.0 V internal reference, DCS enabled, unless otherwise noted.

Table 3.


AD9627

SWITCHING SPECIFICATIONS
Table 4.

| Parameter | Temp | AD9627BCPZ-80 |  |  | AD9627BCPZ-105 |  |  | AD9627BCPZ-125 |  |  | AD9627BCPZ-150 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| CLOCK INPUT PARAMETERS |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Maximum Conversion Rate | Full | 80 |  |  | 105 |  |  | 125 |  |  | 150 |  |  | MSPS |
| Minimum Conversion Rate | Full |  |  | 10 |  |  | 10 |  |  | 10 |  |  | 10 | MSPS |
| CLK Period ( t ¢LK $^{\text {) }}$ | Full | 12.5 |  |  | 9.5 |  |  | 8 |  |  | 6.66 |  |  | ns |
| CLK Pulse Width High ${ }^{1}$ (tcıкн) | Full | TBD | tcı/2 |  | TBD | tcık/2 |  | TBD | tcık/2 |  | TBD | tcık/2 |  | ns |
| CLK Pulse Width Low ${ }^{1}\left(\mathrm{t}_{\text {ckik }}\right)$ | Full | TBD | $\mathrm{tak}_{\text {ck }} / 2$ |  | TBD | $\mathrm{t}_{\mathrm{CLK}} / 2$ |  | TBD | $\mathrm{t}_{\text {cku }} / 2$ |  | TBD | $\mathrm{tak}_{\text {cki }} / 2$ |  | ns |
| CLK Pulse Width $\operatorname{High}^{2}\left(\mathrm{t}_{\text {čKH }}\right)$ | Full | TBD | $\mathrm{t}_{\mathrm{CL}} / 2$ |  | TBD | $\mathrm{t}_{\text {cık }} / 2$ |  | TBD | $\mathrm{t}_{\mathrm{CLK}} / 2$ |  | TBD | $\mathrm{t}_{\mathrm{CK}} / 2$ |  | ns |
| CLK Pulse Width Low² (tckk) | Full | TBD | $\mathrm{tck}^{\text {/ }}$ 2 |  | TBD | tcık/2 |  | TBD | $\mathrm{tcıu} / 2$ |  | TBD | $\mathrm{t}_{\mathrm{ck}} / 2$ |  | ns |
| DATA OUTPUT PARAMETERS |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| Data Propagation Delay ( $\left.\mathrm{tpD}_{\mathrm{P}}\right)^{3}$ | Full |  | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  | ns |
| DCO Propagation Delay (toco) | Full |  | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  | ns |
| Setup Time ( $\mathrm{t}_{s}$ ) | Full |  | 8.5 |  |  | 8.5 |  |  | 8.5 |  |  | 8.5 |  | ns |
| Hold Time ( $\mathrm{t}_{\mathrm{H}}$ ) | Full |  | 8.5 |  |  | 8.5 |  |  | 8.5 |  |  | 8.5 |  | ns |
| Pipeline Delay (Latency) | Full |  | 12 |  |  | 12 |  |  | 12 |  |  | 12 |  | Cycles |
| Aperture Delay ( $\mathrm{t}_{\mathrm{A}}$ ) | Full |  | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  | ns |
| Aperture Uncertainty (Jitter, t, | Full |  | 0.1 |  |  | 0.1 |  |  | 0.1 |  |  | 0.1 |  | ps rms |
| Wake-Up Time ${ }^{4}$ | Full |  | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  | ms |
| OUT-OF-RANGE RECOVERY TIME | Full |  | TBD |  |  | TBD |  |  | TBD |  |  | TBD |  |  |
|  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |


| Parameter (Conditions) | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| RESET TIMING REQUIREMENTS |  |  |  |  |
| $\mathrm{t}_{\text {RESL }} \quad \overline{\text { RESET }}$ Width Low | TBD |  |  | ns |
| SYNC TIMING REQUIREMENTS |  |  |  |  |
| $\mathrm{t}_{\text {ss }} \quad$ SYNC to $\uparrow$ CLK Setup Time | TBD |  |  | ns |
| ths $\quad$ SYNCto $\uparrow$ CLK Hold Time | TBD |  |  | ns |
| SPI TIMING REQUIREMENTS |  |  |  |  |
| $t_{\text {DS }} \quad$ Set-up time between the data and the rising edge of SCLK | 5 |  |  | ns |
| tor ${ }_{\text {d }}$ Hold time between the data and the rising edge of SCLK | 5 |  |  | ns |
| $\mathrm{t}_{\text {CLK }}$ Period of the SCLK | 40 |  |  | ns |
| ts Set-up time between CSB and SCLK | TBD |  |  | ns |
| $\mathrm{t}_{\mathrm{H}} \quad$ Hold time between CSB and SCLK | TBD |  |  | ns |
| $\mathrm{t}_{\text {HI }} \quad$ Minimum period that SCLK should be in a logic high state | TBD |  |  | ns |
| $\mathrm{t}_{\text {LO }} \quad$ Minimum period that SCLK should be in a logic low state | TBD |  |  | ns |

[^2]ABSOLUTE MAXIMUM RATINGS

Table 5.

| Parameter | Rating |
| :--- | :--- |
| ELECTRICAL |  |
| AVDD, DVDD to AGND | -0.3 V to +2.0 V |
| DRVDD to DRGND | -0.3 V to +3.9 V |
| AGND to DRGND | -0.3 V to +0.3 V |
| VIN+A/B, VIN-A/B to AGND | -0.3 V to AVDD +0.2 V |
| CSB to AGND | -0.3 V to +3.9 V |
| D0A/B through D13A/B to DRGND | -0.3 V to DRVDD +0.3 V |
| FD0A/B through FD3A/B to DRGND | -0.3 V to DRVDD +0.3 V |
| DCOA/B to DRGND | -0.3 V to DRVDD +0.3 V |
| VREF to AGND | -0.3 V to AVDD +0.3 V |
| SENSE to AGND | -0.3 V to AVDD +0.2 V |
| ENVIRONMENTAL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Operating Temperature Range |  |
| $\quad$ (Ambient) | $150^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| $\quad$ Under Bias |  |
| Storage Temperature Range (Ambient) |  |

Stresses above those listed under the Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## THERMAL CHARACTERISTICS

The exposed paddle must be soldered to the ground plane for the LFCSP package. Soldering the exposed paddle to the customer board increases the reliability of the solder joints, maximizing the thermal capability of the package.
Table 6. Thermal Resistance

| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}$ | $\boldsymbol{\theta}_{\mathbf{J c}}$ | Unit |
| :--- | :--- | :--- | :--- |
| 64 lead LFCSP 9 mm sq. <br> (CP-64-3) | 24 | TBD | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Typical $\theta_{J A}$ and $\theta_{J C}$ are specified for a 4-layer board in still air. Airflow increases heat dissipation effectively reducing $\theta_{J A}$. In addition, metal in direct contact with the package leads from metal traces, and through holes, ground, and power planes, reduces the $\theta_{\mathrm{JA}}$.

## ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Table 7. LFCSP Parallel CMOS Pin Configuration (Top View)


Table 8. Pin Function Descriptions (Parallel CMOS Mode)

| Pin No. | Mnemonic | Type | Function |
| :---: | :---: | :---: | :---: |
| 20,64 | DRGND | Gnd | Digital Output Ground |
| 1,21 | DRVDD | Supply | Digital Output Driver Supply (1.8V to 3.3V) |
| 24, 57 | DVDD | Supply | Digital Power Supply (1.8V Nominal) |
| 36, 45, 46 | AVDD | Supply | Analog Power Supply (1.8V Nominal) |
| 0 | AGND | Gnd | Analog Ground (Pin 0 is the exposed thermal pad on the bottom of the package) |
| 12, 13, 58, 59 | NC |  | Do Not Connect |


| Pin No. | Mnemonic | Type | Function |
| :---: | :---: | :---: | :---: |
| ADC INPUTS |  |  |  |
| 37 | VIN+A | Input | Differential Analog Input Pin (+) for Channel A. |
| 38 | VIN-A | Input | Differential Analog Input Pin (-) for Channel A. |
| 44 | VIN+B | Input | Differential Analog Input Pin (+) for Channel B. |
| 43 | VIN-B | Input | Differential Analog Input Pin (-) for Channel B. |
| 39 | VREF | I/O | Voltage Reference Input/Output. |
| 40 | SENSE | Input | Voltage Reference Mode Select (See Table x for details) |
| 42 | RBIAS | Input | External Reference Bias Resistor |
| 41 | CML | Output | Common Mode Level Bias Output for Analog Inputs |
| 49 | CLK+ | Input | ADC Master Clock - True (ADC Clock can be driven using single ended CMOS - See Figure x.x for recommended connection) |
| 50 | CLK- | Input | ADC Master Clock - Complement (ADC Clock can be driven using single ended CMOS - See Figure x.x for recommended connection) |
| ADC Fast Detect Outputs |  |  |  |
| 29 | FDOA | Output | Channel A Fast Detect Indicator (See Table x for full detials) |
| 30 | FD1A | Output | Channel A Fast Detect Indicator (See Table x for full detials) |
| 31 | FD2A | Output | Channel A Fast Detect Indicator (See Table x for full detials) |
| 32 | FD3A | Output | Channel A Fast Detect Indicator (See Table $x$ for full detials) |
| 53 | FDOB | Output | Channel B Fast Detect Indicator (See Table x for full detials) |
| 54 | FD1B | Output | Channel B Fast Detect Indicator (See Table $x$ for full detials) |
| 55 | FD2B | Output | Channel B Fast Detect Indicator (See Table x for full detials) |
| 56 | FD3B | Output | Channel B Fast Detect Indicator (See Table x for full detials) |
| Digital INPUTS |  |  |  |
| 52 | SYNC | Input | Digital Synchronization Pin(Slave Mode Only) |
| Digital OUTPUTS |  |  |  |
| $\begin{aligned} & 14,15,16, \\ & 17,18,19 \\ & 22,23,25, \\ & 26,27,28 \end{aligned}$ | D0A-D11A | Output | Channel A CMOS output data |
| $\begin{aligned} & 60,61,62 \\ & 63,2,3,4 \\ & 5,6,7,8,9 \end{aligned}$ | D0B-D11B | Output | Channel B CMOS output data |
| 11 | DCOA | Output | Channel A Data Clock Output |
| 10 | DCOB | Output | Channel B Data Clock Output |
| SPI CONTROL |  |  |  |
| 48 | SCLK/DFS | Input | SPI Serial Clock/Data Format Select Pin in External Pin Mode |
| 47 | SDIO/DCS | I/O | SPI Serial Data I/O/Duty Cycle Stabilizer in External Pin Mode |
| 51 | CSB | Input | SPI Chip Select (Active Low) |
| Serial Port |  |  |  |
| 33 | SMI SDO/OEB | I/O | Signal monitor Serial Data Output/Output Enable Input (Active Low) in External Pin Mode |
| 35 | SMI SDFS | Output | Signal monitor Serial Data Frame Sync |
| 34 | SMI SCLK/PDWN | I/O | Signal monitor Serial Clock Output/Power Down Input in External Pin Mode |

Table 9. LFCSP LVDS Pin Configuration (Top View)


## EQUIVALENT CIRCUITS



Figure 2. Analog Input Circuit


Figure 3. Equivalent Clock IInput Circuit


Figure 4. Digital Output


Figure5x. Equivalent SDIO/DCS Input Circuit


Figure 6. Equivalent SCLK/DFS Input Circuit


Figure7. Equivalent SENSE Circuit


Figure 8. Equivalent CSB Input Circuit


## Preliminary Technical Data <br> TYPICAL PERFORMANCE CHARACTERISTICS

AVDD $=1.8 \mathrm{~V} ; \mathrm{DVDD}=1.8 \mathrm{~V} ; \mathrm{DRVDD}=1.8 \mathrm{~V}$; Sample Rate $=150 \mathrm{MSPS}, \mathrm{DCS}$ enabled, 1 V internal reference; 2 V p-p differential input; VIN $=-1.0 \mathrm{dBFS} ; 64 \mathrm{k}$ sample; $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

## TIMING DIAGRAMS



Figure 39. Reset Timing Requirements


Figure 20. SYNC Input Timing

## TERMINOLOGY

## Crosstalk

Coupling onto one channel being driven by a ( -0.5 dBFS ) signal when the adjacent interfering channel is driven by a full-scale signal. Measurement includes all spurs resulting from both direct coupling and mixing components.

## IF Sampling (Undersampling)

Due to the effects of aliasing, an ADC is not necessarily limited to Nyquist sampling. Frequencies above Nyquist are aliased and appear in the first Nyquist zone (dc to Sample Rate/2). Care must be taken to limit the bandwidth of the sampled signal so that it does not overlap Nyquist zones and alias onto itself. IF sampling performance is limited by the bandwidth of the input SHA (sample-and-hold amplifier) and clock jitter. (Jitter adds more noise at higher input frequencies.)

## Nyquist Sampling (Oversampling)

Oversampling occurs when the frequency components of the analog input signal are below the Nyquist frequency ( $\mathrm{F}_{\text {clock }} / 2$ ), and requires that the analog input frequency be sampled at least
two samples per cycle.

## Out-of-Range Recovery Time

Out-of-range recovery time is the time it takes for the analog-to-digital converter (ADC) to reacquire the analog input after a transient from $10 \%$ above positive full scale to $10 \%$ above negative full scale, or from $10 \%$ below negative full scale to $10 \%$ below positive full scale.

## Signal-to-Noise Ratio (SNR)

The ratio of the rms value of the measured input signal to the rms sum of all other spectral components within the programmed DDC filter bandwidth, excluding the first six harmonics and dc. The value for SNR is expressed in decibels (dB).

## Two-Tone IMD Rejection

The ratio of the rms value of either input tone to the rms value of the worst third-order intermodulation product; reported in dBc.ADC Equivalent Circuits

## THEORY OF OPERATION

The AD9627 dual ADC design may be used for diversity reception of signals, where the ADCs are operating identically on the same carrier but from two separate antennae. The ADCs can also be operated with independent analog inputs. The user can sample any fs/2 frequency segment from dc to 100 MHz using appropriate low-pass or band-pass filtering at the ADC inputs with little loss in ADC performance. Operation to 200 MHz analog input is permitted, but at the expense of increased ADC distortion.

In non-diversity applications, the AD9627 can be used as a baseband receiver where one ADC is used for I input data and the other used for Q input data.

Synchronizaton capability is provided to allow synchronized timing between multiple channels or multiple devices.

Programming and control of the AD9627 is accomplished using a 3-bit SPI compatible serial interface.

## ADC ARCHITECTURE

The AD9627 architecture consists of a dual front-end sample and hold amplifier (SHA) followed by a pipelined switched capacitor ADC. The quantized outputs from each stage are combined into a final 12 -bit result in the digital correction logic. The pipelined architecture permits the first stage to operate on a new input sample, while the remaining stages operate on preceding samples. Sampling occurs on the rising edge of the clock.

Each stage of the pipeline, excluding the last, consists of a low resolution flash ADC connected to a switched capacitor DAC and interstage residue amplifier (MDAC). The residue amplifier magnifies the difference between the reconstructed DAC output and the flash input for the next stage in the pipeline. One bit of redundancy is used in each stage to facilitate digital correction of flash errors. The last stage simply consists of a flash ADC.

The input stage of each channel contains a differential SHA that can be ac- or dc-coupled in differential or single-ended modes. The output-staging block aligns the data, carries out the error correction, and passes the data to the output buffers. The output buffers are powered from a separate supply, allowing adjustment of the output voltage swing. During power-down, the output buffers go into a high impedance state.

## ANALOG INPUT CONSIDERATIONS

The analog input to the AD9627 is a differential switched capacitor SHA that has been designed for optimum performance while processing a differential input signal.

The clock signal alternatively switches the SHA between sample mode and hold mode (see x). When the SHA is switched into sample mode, the signal source must be capable of charging the
sample capacitors and settling within one-half of a clock cycle. A small resistor in series with each input can help reduce the peak transient current required from the output stage of the driving source. A shunt capacitor can be placed across the inputs to provide dynamic charging currents. This passive network creates a low-pass filter at the ADC's input; therefore, the precise values are dependant upon the application.

In IF undersampling applications, any shunt capacitors should be reduced. In combination with the driving source impedance, they would limit the input bandwidth. See the application notes AN-742 and AN-827, and the Analog Dialogue article "Transformer-Coupled Front-End for Wideband A/D Converters" for more information on this subject. In general, the precise values are dependent on the application.


Figure21. Switched-Capacitor SHA Input
For best dynamic performance, the source impedances driving VIN+ and VIN- should be matched.

An internal differential reference buffer creates positive and negative reference voltages that define the input span of the ADC core. The span of the ADC core is set by the buffer to be 2XVREF.

## Input Common Mode

The analog inputs of the AD9627 are not internally dc-biased. In ac-coupled applications, the user must provide this bias externally. Setting the device so that $V_{C M}=0.5 \times$ AVDD is recommended for optimum performance, but the device functions over a wider range with reasonable performance (see Figure x). An on-board common-mode voltage reference is included in the design and is available from the CML pin. Optimum performance is achieved when the common-mode voltage of the analog input is set by the CML pin voltage (typically $0.55 \times$ AVDD).

## Differential Input Configurations

Optimum performance is achieved while driving the AD9627 in a differential input configuration. For baseband applications, the AD8138 differential driver provides excellent performance and a flexible interface to the ADC. The output common-mode
voltage of the AD8352 is easily set with the CML pin of the AD9627 (see Figure 4), and the driver can be configured in a Sallen-Key filter topology to provide band limiting of the input signal.


Figure 4. Differential Input Configuration Using the AD8138
For baseband applications where SNR is a key parameter, differential transformer coupling is the recommended input configuration. An example is shown in Figure 5. The CML voltage can be connected to the center tap of the transformer's secondary winding to bias the analog input.

The signal characteristics must be considered when selecting a transformer. Most RF transformers saturate at frequencies below a few MHz , and excessive signal power can also cause core saturation, which leads to distortion.


Figure 5. Differential Transformer-Coupled Configuration
At input frequencies in the second Nyquist zone and above, the noise performance of most amplifiers is not adequate to achieve the true SNR performance of the AD9627. For applications where SNR is a key parameter, differential double balun coupling is the recommended input configuration. An example is shown in Figure 6.


Figure 6. Differential Double Balun Input Configuration


Figure 7. Differential Input Configuration Using the AD8352
An alternative to using a transformer coupled input at frequencies in the second Nyquist zone is to use the AD8352 differential driver. An example is shown in Figure 7. See the AD8352 datsheet for more information.

In any configuration, the value of the shunt capacitor, $C$, is dependent on the input frequency and source impedance and may need to be reduced or removed. Table 1 displays recommended values to set the RC network. However, these values will be dependant on the input signal and should only be used as a starting guide.

Table 1 Example RC Network

| Frequency Range <br> MHz | R series <br> $(\Omega$, each $)$ | C differential <br> $(\mathrm{pF})$ |
| :---: | :---: | :---: |
| $0-70$ | 33 | 15 |
| $70-200$ | 33 | 5 |
| $200-300$ | 15 | 5 |
| $>$ | 15 | Open |

## Single-Ended Input Configuration

A single-ended input can provide adequate performance in cost-sensitive applications. In this configuration, SFDR and distortion performance degrade due to the large input common-mode swing. If the source impedances on each input are matched, there should be little effect on SNR performance.

Figure 8 details a typical single-ended input configuration.


Figure 8. Single-Ended Input Configuration

Table 2. Reference Configuration Summary

| Selected Mode | SENSE Voltage | Resulting VREF (V) | Resulting Differential <br> Span (V p-p) |
| :--- | :--- | :--- | :--- |
| External Reference | AVDD | N/A | $2 \times$ External Reference |
| Internal Fixed Reference | VREF | 0.5 | 1.0 |
| Programmable Reference | 0.2 V to VREF | $0.5 \times\left(1+\frac{R 2}{R 1}\right)$ (See Figure 10) | $2 \times$ VREF |
|  |  | 1.0 | 2.0 |
| Internal Fixed Reference | AGND to 0.2 V |  |  |

## VOLTAGE REFERENCE

A stable and accurate voltage reference is built into the AD9627. The input range can be adjusted by varying the reference voltage applied to the AD9627, using either the internal reference or an externally applied reference voltage. The input span of the ADC tracks reference voltage changes linearly. The various reference modes are summarized in the next few sections. The Reference Decoupling section describes the best practices PCB layout of the reference.

## Internal Reference Connection

A comparator within the AD9627 detects the potential at the SENSE pin and configures the reference into four possible states, which are summarized in Table x. If SENSE is grounded, the reference amplifier switch is connected to the internal resistor divider (see Figure 9), setting VREF to 1 V . Connecting the SENSE pin to VREF switches the reference amplifier output to the SENSE pin, completing the loop and providing a 0.5 V reference output. If a resistor divider is connected external to the chip as shown in Figure 10, the switch again sets to the SENSE pin. This puts the reference amplifier in a noninverting mode with the VREF output defined as

$$
\mathrm{VREF}=0.5 \times\left(1+\frac{\mathrm{R} 2}{\mathrm{R} 1}\right)
$$

The input range of the ADC always equals twice the voltage at the reference pin for either an internal or an external reference.


Figure 9. Internal Reference Configuration


Figure 10. Programmable Reference Configuration
If the internal reference of the AD9627 is used to drive multiple converters to improve gain matching, the loading of the reference by the other converters must be considered. Figure 11 depicts how the internal reference voltage is affected by loading.


Figure 11. VREF Accuracy vs. Load

## External Reference Operation

The use of an external reference may be necessary to enhance the gain accuracy of the ADC or improve thermal drift characteristics. Figure 12 shows the typical drift characteristics of the internal reference in both 1 V and 0.5 V modes.


Figure 12. Typical VREF Drift
When the SENSE pin is tied to AVDD, the internal reference is
disabled, allowing the use of an external reference. An internal reference buffer loads the external reference with an equivalent TBD $k \Omega$ load. The internal buffer generates the positive and negative full-scale references for the ADC core. Therefore, the external reference must be limited to a maximum of 1 V .

## CLOCK INPUT CONSIDERATIONS

For optimum performance, the AD9627 sample clock inputs (CLK+ and CLK-) should be clocked with a differential signal. The signal is typically ac-coupled into the CLK+ and CLK- pins via a transformer or capacitors. These pins are biased internally (See Figure 13) and require no external bias.


Figure

## Figure 13.Equivalent Clock Input Circuit

## Clock Input Options

The AD9627 has a very flexible clock input structure. The clock input can be a CMOS, LVDS, LVPECL, or sine wave signal. Regardless of the type of signal being used, the jitter of the clock source is of the most concern, as described in the Jitter Considerations section.

Figure 14 shows one preferred method for clocking the AD9627 (at clock rates to 150 MSPS ). A low jitter clock source is converted from single-ended to differential signal using an RF transformer. The back-to-back Schottky diodes across the transformer secondary limit clock excursions into the AD9627 to approximately $0.8 \mathrm{Vp}-\mathrm{p}$ differential. This helps prevent the large voltage swings of the clock from feeding through to other portions of the AD9627 while preserving the fast rise and fall times of the signal, which are critical to a low jitter performance.


## Figure 14. Transformer Coupled Differential Clock(up to 150MSPS)

If a low jitter clock source is not available, another option is to ac-couple a differential PECL signal to the sample clock input pins as shown in Figure 15. The AD9510/AD9511/AD9512/ AD9513/AD9514/AD9515 family of clock drivers offers excellent jitter performance.


Figure 15. Differential PECL Sample Clock (up to 150MSPS)
A third option is to ac-couple a differential LVDS signal to the sample clock input pins as shown in Figure 16. The
AD9510/AD9511/AD9512/ AD9513/AD9514/AD9515 family of clock drivers offers excellent jitter performance.


Figure 16 Differential LVDS Sample Clock (up to 150MSPS)
In some applications it may acceptable to drive the sample clock inputs with a single ended CMOS signal. In such applications, CLK + should be directly driven from a CMOS gate, while the CLK- pin should be bypassed to ground with a 0.1 uF capacitor in parallel with a $39 \mathrm{k} \Omega$ resistor (see Figure 17). CLK+ may be directly driven from a CMOS gate. Although the CLK+ input circuit supply is AVDD ( 1.8 V ), this input is designed to withstand input voltages up to 3.6 V , making the selection of the drive logic voltage very flexible.


Figure 17. Single-ended 1.8V CMOS Sample Clock (up to 150MSPS)


Figure 18 Single-ended 3.3V CMOS Sample Clock (up to 150MSPS)

## Input Clock Divider

The AD9627 contains an input clock divider with the ability to divide the input clock by integer values between 1 and 8 . If a divide ratio other than 1 is selected the duty cycle stabilizer will be automatically enabled.

The AD9627 clock divider can be synchronized using the external SYNC input. Register 0x100 bits bits 1 and 2 allow the clock divider to be re-synchronized on every SYNC signal or only on the first SYNC signal after the register is written. A valid SYNC causes the clock divider to reset to its initial state. This synchronization feature allows multiple parts to have their clock dividers aligned to guarantee simultaneous input sampling.

## Clock Duty Cycle

Typical high speed ADCs use both clock edges to generate a variety of internal timing signals, and as a result may be sensitive to clock duty cycle. Commonly, a $\pm 5 \%$ tolerance is required on the clock duty cycle to maintain dynamic performance
characteristics. The AD9627 contains a duty cycle stabilizer (DCS) that retimes the nonsampling, or falling, edge, providing an internal clock signal with a nominal $50 \%$ duty cycle. This allows the user to provide a wide range of clock input duty cycles without affecting the performance of the AD9627. Noise and distortion performance are nearly flat for a wide range of duty cycles with the DCS on, as shown in Figure x.

The duty cycle stabilizer uses a delay-locked loop (DLL) to create the nonsampling edge. As a result, any changes to the sampling frequency require approximately TBD clock cycles to allow the DLL to acquire and lock to the new rate.

## Jitter Considerations

High speed, high resolution ADCs are sensitive to the quality of the clock input. The degradation in SNR at a given input frequency ( $\mathrm{f}_{\text {INPUT }}$ ) due to jitter $\left(\mathrm{t}_{\mathrm{J}}\right)$ can be calculated by:

$$
\mathrm{SNR}=-20 \log \left[2 \pi f_{\text {INPUT }} \times t_{J}\right]
$$

In the equation, the rms aperture jitter represents the rootmean square of all jitter sources, which include the clock input, analog input signal, and ADC aperture jitter specification. IF undersampling applications are particularly sensitive to jitter, as
illustrated in Figure 19.


Figure 19. SNR vs. Input Frequency and Jitter
The clock input should be treated as an analog signal in cases where aperture jitter may affect the dynamic range of the AD9627. Power supplies for clock drivers should be separated from the ADC output driver supplies to avoid modulating the clock signal with digital noise. Low jitter, crystal-controlled oscillators make the best clock sources. If the clock is generated from another type of source (by gating, dividing, or other methods), it should be retimed by the original clock at the last step.

Refer to the AN-501 Application Note and the AN-756 Application Note for more in-depth information about jitter performance as it relates to ADCs. See www.analog.com.

## POWER DISSIPATION AND STANDBY MODE

As shown in Figure 20, the power dissipated by the AD9627 is proportional to its sample rate. In CMOS output mode, the digital power dissipation is determined primarily by the strength of the digital drivers and the load on each output bit. The maximum DRVDD current (IDRVDD) can be calculated as:

$$
\mathrm{I}_{\mathrm{DRVDD}}=\mathrm{V}_{\text {DRVDD }} \times \mathrm{C}_{\text {LOAD }} \times \mathrm{f}_{\mathrm{CLK}} \times \mathrm{N}
$$

where $N$ is the number of output bits, 12 in the case of the AD9627. This maximum current occurs when every output bit switches on every clock cycle, that is, a full-scale square wave at the Nyquist frequency, fcli/2. In practice, the DRVDD current is established by the average number of output bits switching, which is determined by the sample rate and the characteristics of the analog input signal. Reducing the capacitive load presented to the output drivers can minimize digital power consumption. The data in Figure 20 was taken with the same operating conditions as the Typical Performance Characteristics with a 5 pF load on each output driver.


Figure 20. Power vs. Clock Frequency@ 30 MHz
By asserting the PDWN mode (either through the SPI port or by asserting the PDWN pin high), the AD9627 is placed in power-down mode. In this state, the ADC typically dissipates TBD mW. During power-down, the output drivers are placed in a high impedance state. Asserting the PDWN pin low returns the AD9627 to its normal operational mode. This pin is both 1.8 V and 3.3 V tolerant.

Low power dissipation in power-down mode is achieved by shutting down the reference, reference buffer, biasing networks, and clock. Internal capacitors are discharged when entering power-down mode and then must be recharged when returning to normal operation. As a result, the wake-up time is related to the time spent in power-down mode and shorter power-down cycles result in proportionally shorter wake-up times. It takes approximately TBD sec to fully discharge the internal reference buffer decoupling capacitors and TBD ms to restore full operation.

When using the SPI port interface, the user can place the ADC in power-down or standby modes. Standby mode allows the user to keep the internal reference circuitry powered when faster wake-up times are required. See the SPI Register Map Description section for more details.

## DIGITAL OUTPUTS

The AD9627 output drivers can be configured to interface with 1.8 V to 3.3 V logic families by matching DRVDD to the digital supply of the interfaced logic.

In CMOS output mode, the output drivers are sized to provide sufficient output current to drive a wide variety of logic families. However, large drive currents tend to cause current glitches on the supplies that may affect converter performance. Applications requiring the ADC to drive large capacitive loads or large fan-outs may require external buffers or latches.

The output data format can be selected for either offset binary or twos complement by setting the CLK/DFS pin when operating in the external pin mode (see Table 3). As detailed in the memory map register description section the data format can be selected for either offset binary, twos complement, or

Gray code when using the SPI control.
Table 3. CLK/DFS Mode Selection (external pin mode)

| Voltage at pin | SCLK/DFS | SDIO/DCS |
| :--- | :--- | :--- |
| AGND (default) | Binary | DCS Disabled |
| AVDD | Twos Complement | DCS Enabled |

## Digital Output Enable Function (OEB)

The AD9627 has a flexible three-state ability for the digital output pins. The three-state mode can be enabled using the OEB pin or through the SPI interface. If the OEB pin is low, the output data drivers are enabled. If the OEB pin is high, the output data drivers are placed in a high impedance state. It is not intended for rapid access to the data bus. Note that OEB is referenced to the digital supplies (DRVDD) and should not exceed that supply voltage.

When using the SPI interface each channel's data and fast detect outputs can be independently three-stated by using the Output Enable Bar bit in register 0x14.


Figure 21. OR Relation to Input Voltage and Output Data

## TIMING

The AD9627 provides latched data with a pipeline delay of twelve clock cycles. Data outputs are available one propagation delay ( $t_{\text {pD }}$ ) after the rising edge of the clock signal.

The length of the output data lines and loads placed on them should be minimized to reduce transients within the AD9627. These transients can degrade the converter's dynamic performance. The AD9627 also provides data clock output (DCO) intended for capturing the data in an external register. The data outputs are valid on the rising edge of DCO . See Figure x for a graphical timing description.

The lowest typical conversion rate of the AD9627 is 10 MSPS. At clock rates below 10 MSPS, dynamic performance can degrade.

Table 4. Output Data Format

| Input (V) | Condition (V) | Binary Output Mode | Twos Complement Mode | OR |
| :--- | :--- | :--- | :--- | :--- |
| VIN+ - VIN- | <-VREF - 0.5 LSB | 000000000000 | 100000000000 | 1 |
| VIN+ - VIN- | $=-$ VREF | 000000000000 | 100000000000 | 0 |
| VIN+ VIN- | $=$ | 100000000000 | 000000000000 | 0 |
| VIN+ - VIN- | $=+$ VREF - 1.0 LSB | 111111111111 | 011111111111 | 0 |
| VIN+ - VIN- | >+VREF - 0.5 LSB | 111111111111 | 011111111111 | 1 |

## ADC OVERRANGE AND GAIN CONTROL

It is desirable to have a mechanism to reliably determine when the converter is about to be clipped. The standard overflow indicator provides after the fact information which is of limited usefulness. Therefore it is useful to have a programmable threshold below full-scale that would allow time to reduce the gain before the clip actually occurs. In addition, since input signals can have significant slew rates, latency of this function is a big concern. Highly pipelined converters can have significant latency. A good compromise of this function is to use the output bits from the first stage of the ADC for this function. Latency for these output bits is very low, and overall resolution is not highly significant. Peak input signals are typically between full-scale and 6 to 10 dB below full-scale. A 3 or 4 bit output should give more than adequate range and resolution for this function.

Via the SPI port, the user can provide a threshold above which a fast over-range output would be active. As long as the signal is below that threshold, the output should remain low. This pin could also be programmed via the SPI port to function as a traditional over-range pin for customers who currently use this feature. In this mode, all 12 bits of the converter would be examined in the traditional manner and the output would be high for the condition normally defined as overflow. In either mode, the sign of the data is not considered in the calculation of the condition. The threshold detection responds identically to positive and negative signals outside the desired range (magnitude).

## FAST DETECT OVERVIEW

The AD9627 contains circuitry to facilitate fast over-range detection allowing very flexible external gain control implementations. Each ADC has four Fast Detect (FD) bits that are utilized to output information about the current state of the ADC input level. The FD bit function is programmable allowing range information to be output from several points in the internal data path. These bits can also be set up to indicate the presence of overrange or underrange conditions according to programmable threshold levels. Table X.x below shows the 6 configurations available for the Fast Detect bits. These configurations are selecting by setting bits 3:1 in the register at SPI address 0x104.
Table xx. Fast Detect Bit Configuration Settings

| Fast Detect Mode <br> Select - Register <br> $104 h<3: 1>$ | Information Presented on <br> FD Bits[3:0] |
| :--- | :--- |
| 000 | ADC Fast Magnitude[3:0] |
| 001 | ADC Fast Magnitude[2:0], OVR |
| 010 | ADC Fast Magnitude[2:1], OVR, F_LT |
| 011 | ADC Fast Magnitude[2:1], C_UT, F_LT |
| 100 | OVR, C_UT, F_UT, F_LT |
| 101 | OVR, F_UT, IG, DG |

## ADC FAST MAGNITUDE

When the FD bits are configured to output the ADC fast magnitude the information presented is the ADC level with only a 1 clock cycle latency. Using the FD bits in this configuration provides the earliest possible level indication information. Since this information is provided from early in the data path there is a significant uncertainty in the level indicated. The nominal levels along with the uncertainty indicated by the ADC fast magnitude are shown in table x.x.
Table xx. ADC Fast Magnitude Bits Nomimal Levels (Using Mag[3:0])

| ADC_Fast_Mag[3:0] | Nominal Input <br> magnitude in <br> dB below FS | Nominal Input <br> magnitude <br> Uncertainty in dB |
| :--- | :---: | :---: |
| 0000 | -30.14 | +12.07 to Min |
| 0001 | -18.07 | $+6.03 /-12.07$ |
| 0010 | -12.04 | $+3.52 /-6.03$ |
| 0011 | -8.52 | $+2.5 /-3.52$ |
| 0100 | -6.02 | $+1.94 /-2.5$ |
| 0101 | -4.08 | $+1.58 /-1.94$ |
| 0110 | -2.5 | $+1.34 /-1.58$ |
| 0111 | -1.16 | $+1.16 /-1.34$ |
| 1000 | -0.28 | $+0.28 /-0.88$ |

When fast detect modes 001,010 , or 011 are selected a subset of the FD bits are available. Table xx shows the corresponding ADC input levels when Fast Magnitude[2:0] is selected using 001.

Table xx. ADC Fast Magnitude Bits Nomimal Levels (Using Mag[2:0])

| ADC_Fast_Mag[2:0] | Nominal Input <br> magnitude in <br> dB below FS | Nominal Input <br> magnitude <br> Uncertainty in dB |
| :--- | :---: | :---: |
| 000 | -30.14 | +12.07 to Min |
| 001 | -18.07 | $+6.03 /-12.07$ |
| 010 | -12.04 | $+3.52 /-6.03$ |
| 011 | -8.52 | $+2.5 /-3.52$ |
| 100 | -6.02 | $+1.94 /-2.5$ |
| 101 | -4.08 | $+1.58 /-1.94$ |
| 110 | -2.5 | $+1.34 /-1.58$ |
| 111 | -1.16 | $+1.16 /-1.34$ |

When ADC Fast Magnitude[2:1] is selected the LSB is not provided. The Input ranges for this mode are shown in Table x.
Table xx. ADC Fast Magnitude Bits Nomimal Levels (Using Mag[2:1])

|  | Nominal Input <br> magnitude in <br> dB below FS | Nominal Input <br> magnitude <br> Uncertainty in dB |
| :--- | :---: | :---: |
| 00 | -22.14 | +10.1 to Min |
| 01 | -10.10 | $+4.08 /-7.97$ |
| 10 | -5.00 | $+2.5 /-3.52$ |
| 11 | -1.48 | $+1.48 /-2.6$ |

## ADC OVERRANGE (OVR)

The ADC Overrange bit becomes active when an overrange is detected on the input of the ADC. The overrange condition is determined at the output of the ADC pipline and is therefore subject to the TBD ADC clock cycle latency. So an overrange at the input would be indicated by this bit TBD clock cycles after it occurred.

## GAIN SWITCHING

The AD9627 includes circuitry that is useful in applications where either large dynamic ranges exist or where gain ranging converters are employed. This circuitry allows digital thresholds to be set such that an upper and a lower threshold can be programmed. Fast detect modes 2 through 7 support various combinations of the gain switching options.

One such use of this may be to detect when an ADC is about to reach full scale with a particular input condition. The results would be to provide a flag that could be used to quickly insert an attenuator that would prevent ADC overdrive.

## Coarse Upper Threshold (C_UT)

The coarse upper threshold bit is asserted if the input level present on the ADC Fast Magnitude bits is greater than the level programmed in the coarse upper threshold register at address $0 \times 105$ bits [2:0]. This value is compared with the ADC Fast Magnitude Bits [2:0]. The coarse upper threshold levels are shown in Table x.x. This bit remains asserted for a minimum of 2 ADC clock cycles or until the signal drops below the threshold level.

Table xx. Fast Magnitude Nominal Threshold Levels

| Coarse Upper <br> Threshold Register <br> [2:0] | C_UT active when <br> signal magnitude <br> in dB below FS is <br> greater than |
| :--- | :--- |
| 000 | TBD |
| 001 | TBD |
| 010 | TBD |
| 011 | TBD |
| 100 | TBD |
| 101 | TBD |
| 110 | TBD |
| 111 |  |

## Fine Upper Threshold (F_UT)

The Fine Upper Threshold bit will be asserted if the input magnitude exceeds the value programmed in the Fine Upper Threshold Register located at addresses $0 \times 106$ and $0 \times 107$. This
is a 13 bit threshold register that is compared with the magnitude at the output of the ADC. This comparison is subject to the ADC clock latency but allows a finer, more accurate comparison. The fine threshold magnitude is defined by equation $\mathrm{x} . \mathrm{x}$.
$\mathrm{dBFS}=20 \log ($ threshold mag/2^13)

## Fine Lower Threshold (F_LT)

The Fine Lower Threshold bit will be asserted if the input magnitude is less than value programmed in the Fine Lower Threshold Register located at addresses 0x108 and 0x109. The fine lower threshold register is a 13 bit register that is compared with the magnitude at the output of the ADC. This comparison is delayed by the ADC clock latency but provides an accurate comparison. The fine threshold magnitude is defined by equation $\mathrm{x} . \mathrm{x}$.
$\mathrm{dBFS}=20 \log ($ threshold mag/2^13)

## Increment Gain (IG) and Decrement Gain (DG)

The Increment Gain and decrement gain outputs are intended to be used together to provide information to enable external gain control. The Decrement Gain output works identically to the Coarse Upper Threshold output. This bit is asserted when the input magnitude is greater than the three bit value in the Coarse Upper Threshold Register. The Increment Gain output is similar to the Fine Lower Threshold bit except that it will be asserted only if the input magnitude is less than value programmed in the Fine Lower Threshold Register for greater than the 16 bit Dwell Time value located at addresses 0x10A and $0 \times 10 \mathrm{~B}$. The dwell time is set in units of ADC input clock cycles ranging from 1 to 65535 . The fine lower threshold register is a 13 bit register that is compared with the magnitude at the output of the ADC. This comparison is subject to the ADC clock latency but allows a finer, more accurate comparison. The fine threshold magnitude is defined by equation $\mathrm{x} . \mathrm{x}$.

The decrement gain output works off the ADC fast detect bits providing a fast indication of potential overrange conditions. The increment gain uses the comparison at the output of the ADC requiring the input magnitude to remain below an accurate programmable level for a predefined period before signaling external circuitry to increase the gain.

The operation of the increment gain and decrement gain bits is shown in Figure x.x.

| Preliminary Technical Data | AD9627 |
| :--- | :---: |



Figure 22. Threshold Settings for IG and DG

## SIGNAL MONITOR

The Signal monitoring block serves to characterize the signal being digitized by the ADC. It operates in one to three modes to compute the RMS Input Magnitude, Peak Magnitude, and/or the number of samples that the Magnitude crosses a particular threshold. Together these functions can be used to gain insight into the signal characteristics and can be used to estimate the Peak/Average ratio or even the shape of the CCDF curve (peak to average ratio) of the input signal. This information can be used to drive an AGC loop and to optimize the range of the ADC in the presence of real world signals.

The signal monitor result values can be obtained from the part by either reading back internal registers at addresses $0 \times 116$ to 0x11B using the SPI port or by using the signal monitor SPORT output. The output contents of the SPI accessible signal monitor registers is set via the 2 power-monitor mode bits of the signal monitor control register. Both ADC channels must be configured for the same signal monitor mode. Separate SPI accessible 20 bit Signal monitor Value (PMV) output registers are provided for each ADC channel. Any combination of the signal monitor functions can also be output to the user via a serial SPORT interface. These outputs are enabled using the Peak Power Output Enable, RMS Magnitude Output Enable, and Threshold Crossing Output Enable bits in the Signal monitor SPORT Control Register.

For each of the signal monitor measurements a programmable Signal Monitor Period Register (SMPR) controls the duration of the measurement. This time period is programmed as the number of input clock cycles in a 24 -bit ADC monitor period register located at addresses $0 \times 113,0 \times 114$, and $0 \times 115$. This register can be programmed with a period from 128 samples to 16.78 ( $2 \wedge 24$ ) million samples.

Since the DC offset of the ADC can be significantly larger than the signal of interest a simple DC correction circuit is included as part of the signal monitor block to null the DC offset before measuring the power.

## PEAK DETECTOR MODE (MODE BITS 01)

The magnitude of the input port signal is monitored over a programmable time period (given by SMPR) to give the peak value detected. This function is enabled by programming a logic 1 in the power-monitor mode bits of the power-monitor control register or by setting the Peak Power Output Enable bit in the Signal monitor SPORT Control Register. The 24-bit SMPR must be programmed before activating this mode.

After enabling this mode, the value in the SMPR is loaded into a monitor period timer and the countdown is started. The magnitude of the input signal is compared to the internal peak level holding register, and the greater of the two is updated back into the peak level holding register. The initial value of the peak
level holding register is set to the current ADC input signal magnitude. This comparison continues until the monitor period timer reaches a count of 1 .

When the monitor period timer reaches a count of 1 , the 13 bit value in the peak level holding register is transferred to a holding register, which can be read through the SPI port or output through the SPORT serial interface. The monitor period timer is reloaded with the value in the SMPR, and the countdown is started. Also, the first input sample's magnitude is updated in the peak level holding register, and the comparison and update procedure, as explained above, continues.

Figure 23 is a block diagram of the peak detector logic. The PMV contains the absolute magnitude of the peak detected by the peak detector logic.


Figure 23. ADC Input Peak Detector Block Diagram

## RMS/MS MAGNITUDE MODE (MODE BITS 00)

In this mode, the RMS or MS magnitude of the input port signal is integrated (by adding an accumulator) over a programmable time period (given by SMPR) to give the RMS or MS magnitude of the input signal. This mode is set by programming Logic 0 in the signal monitor mode bits of the signal monitor control register or by setting the RMS Magnitude Output Enable bit in the Signal monitor SPORT Control Register. The 24-bit SMPR, representing the period over which integration is performed, must be programmed before activating this mode.

After enabling this mode, the value in the SMPR is loaded into a monitor period timer, and the countdown is started immediately. Each input sample is converted to floating point format and squared. It is then converted to 11 bit fixed point format and is added to the contents of a 24-bit holding register, thus performing an accumulation. The integration continues until the monitor period timer reaches a count of 1 .

When the monitor period timer reaches a count of 1 , the square root of the value in the holding register is taken and transferred to the power-monitor holding register (after some formatting), which can be read through the SPI port or output through the

SPORT serial port. The monitor period timer is reloaded with the value in the SMPR, and the countdown is restarted. Also, the first input sample signal power is updated in the holding register, and the accumulation continues with the subsequent input samples. Figure 24 illustrates the RMS magnitude monitoring logic.

For RMS magnitude mode, the value in the PMV is a 20 bit fixed point number. The equation shown below can be used to determine the RMS magnitude in dBFS from the MAG value in the register. Note that if the signal monitor period (SMP) is a power of 2, the 2nd term in the equation goes to zero.

$$
\text { RMS_Magnitude }:=20 \cdot \log \left(\frac{\text { MAG }}{2^{20}}\right)-10 \cdot \log \left[\frac{\text { SMP }}{\left.2^{\text {cei }\left[\log _{2}(\text { SMP })\right]}\right]}\right]
$$

For MS magnitude mode, the value in the PMV is a 20 bit fixed point number. The equation shown below can be used to determine the MS magnitude in dBFS from the MAG value in the register. Note that if the signal monitor period (SMP) is a power of 2 , the 2 nd term in the equation goes to zero. MS_Magnitude $:=10 \cdot \log \left(\frac{\text { MAG }}{2^{20}}\right)-10 \cdot \log \left[\frac{\text { SMP }}{\left.2^{\text {cei }\left[\log _{2}(\mathrm{SMP})\right]}\right]}\right.$


Figure 24. ADC Input RMS Magnitude Monitoring Block Diagram

## THRESHOLD CROSSING MODE (MODE BITS 1X)

In this mode of operation, the magnitude of the input port signal is monitored over a programmable time period (given by SMPR) to count the number of times it crosses a certain programmable threshold value. This mode is set by programming Logic 1 x (where x is a don't care bit) in the power-monitor mode bits of the signal monitor control register or by setting the Threshold Crossing Output Enable bit in the Signal monitor SPORT Control Register. Before activating this mode, the user needs to program the 24 -bit SMPR and the 13-bit upper threshold register for each individual input port. The same upper threshold register is used for both signal monitoring and gain control (see the ADC Overrange and Gain Control section).

After entering this mode, the value in the SMPR is loaded into a monitor period timer, and the countdown is started. The magnitude of the input signal is compared to the upper threshold register (programmed previously) on each input clock cycle. If the input signal has magnitude greater than the upper threshold register, then the internal count register is incremented by 1 . The initial value of the internal count register is set to 0 . This comparison and increment of the internal count register continues until the monitor period timer reaches a count of 1 .

When the monitor period timer reaches a count of 1 , the value in the internal count register is transferred to the signal monitor holding register, which can be read through the SPI port or output through the SPORT serial port. The monitor period timer is reloaded with the value in the SMPR, and the countdown is started. The internal count register is also cleared to a value of 0 . Figure 25 illustrates the threshold crossing logic. The value in the PMV is the number of samples that have a magnitude greater than the threshold register.


Figure 25. ADC Input Threshold Crossing Block Diagram

## ADDITIONAL CONTROL BITS

For additional flexibility in the signal monitoring process, two control bits are provided in the power-monitor control register. They are the signal monitor enable bit and the complex power bit.

## Signal monitor Enable Bit

The signal monitor enable bit located in bit 0 or register 0x112 enables operation of the signal monitor block. If the signal monitor function is not needed in a particular application then this bit should be cleared to conserver power.

## Measure Complex Power Bit

When this bit is set the part assumes that Channel A is digitizing the I data and Channel $B$ is digitizing the $Q$ data for a complex input signal (or vice versa). In this mode the power reported is the sqrt( $\left.\mathrm{I}^{\wedge} 2+\mathrm{Q}^{\wedge} 2\right)$. This complex power measurement result is presented in the Channel A signal monitor value register if the signal monitor mode bits are set to 00 . The channel $B$ signal monitor will continue to compute the channel B value.

## DC CORRECTION

Since the DC offset of the ADC can be significantly larger than the signal we are trying to measure a simple DC correction circuit is included to null the DC offset before measuring the power. The DC Correction circuit can also be switched into the main signal path but this may not be appropriate if the ADC is digitizing a time-varying signal with significant DC content such as GSM.

## DC Correction Bandwidth

The DC correction circuit is basically a HP filter with a programmable BW ranging between 0.15 Hz and 1.2 kHz . The BW is controlled by writing the 4-bit DC correction register located in bits 5:2 at address 0x10C. Table xx shows the BW values for each of the 16 possible programmed values.

Table xx. DC Correction Bandwidth Settings

| DC Correction Factor <br> reg.10C $\langle 5: 2>$ | Bandwidth $(\mathrm{Hz})$ |
| :--- | :--- |
| 0000 | 1218.56 |
| 0001 | 609.28 |
| 0010 | 304.64 |
| 0011 | 152.32 |
| 0100 | 76.16 |
| 0101 | 38.08 |
| 0110 | 19.04 |
| 0111 | 9.52 |
| 1000 | 4.76 |
| 1001 | 2.38 |
| 1010 | 1.19 |
| 1011 | 0.60 |
| 1100 | 0.30 |
| 1101 | 0.15 |
| 1110 | 0.15 |
| 1111 | 0.15 |

## DC Correction Readback

The current DC correction value can be read back in registers 0 x 10 D and 0 x 10 E for channel A and registers $0 \times 10 \mathrm{~F}$ and 0 x 110 for channel B . The DC correction value is a 14 bit value that can span the entire input range of the ADC.

## DC Correction Freeze

Setting the DC Correction Freeze bits freezes the DC correction at its current state and continues to use the last updated value as the DC correction value. Clearing this bit restarts the DC correction and adds the currently calculated value to the data.
DC Correction Enable Bits

Setting bit 0 of register 0x10C enables the DC correction for use in the Signal monitor calculations. The calculated DC correction value can be added to the output data signal path by setting bit 1 of register $0 \times 10 \mathrm{C}$.

## SIGNAL MONITOR SPORT OUTPUT

The SPORT is a serial interface with three output pins, the SMI SCLK (SPORT clock), SMI_SDFS (SPORT frame sync) and SMI_SDO (SPORT data). The SPORT is the master, and drives all three pins out of the chip.

## SMI SCLK

The data and frame sync are driven on the positive edge of the SMI SCLK. The SMI SCLK has three possible baud rates. They are $1 / 2,1 / 4$, or $1 / 8$ the ADC clock rate, based on the SPORT controls. The SMI SCLK can also be gated off when not sending any data, based on the SMI SCLK sleep bit. Gating off the SMI SCLK when it is not needed will reduce the coupling errors back into the signal path if these prove to be a problem in the system. This has the disadvantage of spreading the frequency content of the clock so this can be left running to ease frequency planning if desired.

## SMI SDFS

The SMI_SDFS is the Serial Data Frame Sync, and defines the start of a frame. One SPORT frame includes data from both datapaths. The data from Datapath $A$ is sent just after the frame sync, followed by data from Datapath B.

## SMI SDO

The SMI_SDO is the serial data out of the block. The data is sent MSB first on the next positive edge after the SMI_SDFS. Each data output block includes one or more of RMS magnitude, Peak level, and Threshold Crossing values from both datapaths in the stated order. If enabled the data is sent RMS first, followed by Peak, and Threshold as shown in Figure x .


Figure 26. Signal monitor SPORT Output Timing (RMS, Peak, and Threshold Enabled)


Figure 27. Signal monitor SPORT Output Timing (RMS and Threshold Enabled)

## BUILT-IN SELF-TEST (BIST) AND OUTPUT TEST

The AD9627 includes built-in test features to enable verification of the integrity of each channel as well as to facilitate board level debugging. A BIST (built-in self-test) feature is included which verifies the integrity of the digital data path of the AD9627. Various output test options are also provided to place predictable values on the outputs of the AD9627.

## BUILT IN SELF TEST (BIST)

The BIST is a thorough test of the digital portion of the selected AD9627 signal path. When enabled, the test runs from a user selectable internal source ( PN or sine) through the digital data path starting at the ADC block output. The BIST sequence will run for 256 cycles and stop. The BIST signature value for channel A or B will be placed in registers $0 \times 024$ and $0 \times 025$. If one channel is chosen, its BIST signature is written to the two registers. If both channels are chosen, the two channels' results are XOR'ed and placed in the BIST signature register. The outputs are not disconnected during this test, so the PN
sequence can be observed as it runs. The PN sequence can be continued from its last value or start from the beginning based on the value programmed in register 0x00E bit 2. The BIST signature result will vary based on the channel configuration.

## OUTPUT TEST MODES

The output test options are shown in table x.x. When an output test mode is enabled, the analog section of the ADC is disconnected from the digital backend blocks and the test pattern is run through the output formatting block. As indicated in table x.x some of the test patterns are subject to output formatting and some are not. The seed value for the PN sequence tests can be forced if the PN reset bits are used to hold the generator in reset mode by setting bits 4 or 5 of register 0x0D. These tests can be performed with or without an analog signal, but do require an encode clock.

## CHANNEL/CHIP SYNCHRONIZATION

The AD9627 has a SYNC input that allows the user flexible synchronization options for syncing the internal blocks. The sync feature is useful to guarantee synchronized operation across multiple ADCs. The input clock divider and the signal monitor block can be synchronized using the SYNC input. The input clock divider can be enabled to sync on a single occurrence of the sync signal or on every occurrence. The signal monitor syncs on every SYNC input.

The SYNC input is internally synchronized to the sample clock, however to ensure there is no timing uncertainty between multiple parts the SYNC input signal should be synchronized to the input clock signal. The SYNC input should be driven using a single ended CMOS type signal.

## SERIAL PORT INTERFACE (SPI)

The AD9627 serial port interface (SPI) allows the user to configure the converter for specific functions or operations through a structured register space provided inside the ADC. This gives the user added flexibility and customization depending on the application. Addresses are accessed via the serial port and may be written to or read from via the port. Memory is organized into bytes that can be further divided down into fields, which are documented in the Memory Map section. Detailed operational information can be found in the Analog Devices user manual titled Interfacing to High Speed ADCs via SPI at www.analog.com.

## CONFIGURATION USING THE SPI

There are three pins that define the SPI of this ADC. They are the SCLK/DFS, SDIO/DCS, and CSB pins (summarized inTable x ). The SCLK/DFS (serial clock) is used to synchronize the read and write data presented from/to the ADC. The SDIO/DCS (serial data input/output) is a dual purpose pin that allows data to be sent and read from the internal ADC memory map registers. The CSB (chip select bar) is an active low control that enables or disables the read and write cycles.
Table xx. Serial Port Interface Pins

| Pin | Function |
| :--- | :--- |
| SCLK | SCLK (Serial Clock) is the serial shift clock in. SCLK is <br> used to synchronize serial interface reads and writes. <br> SDIO <br> SDIO (Serial Data Input/Output) is a dual purpose pin. <br> The typical role for this pin is an input and output <br> depending on the instruction being sent and the <br> relative position in the timing frame. <br> CSB (Chip Select Bar) is active low controls that gates <br> the read and write cycles. |

The falling edge of the CSB in conjunction with the rising edge of the SCLK determines the start of the framing. An example of the serial timing and its definitions can be found in Figure x and Table x .

Other modes involving the CSB are available. The CSB can be held low indefinitely which permanently enabling the device, this is called streaming. The CSB may stall high between bytes to allow for additional external timing. When CSB is tied high, SPI functions are placed in a high impedance more. This mode turns on any SPI pin secondary functions.

During an instruction phase a 16bit instruction is transmitted. Data follows the instruction phase and it's length is determined by the W0 and W1 bits. All data is composed of 8bit words. The first bit of each individual byte of serial data indicates whether a read or write command is issued. This allows the serial data input/output (SDIO) pin to change direction from an input to an output.

In addition to word length, the instruction phase determines if the serial frame is a read or write operation, allowing the serial
port to be used both to program the chip as well as read the contents of the on-chip memory. If the instruction is a readback operation, performing a readback causes the serial data input/ output (SDIO) pin to change direction from an input to an output at the appropriate point in the serial frame.

Data may be sent in MSB or in LSB first mode. MSB first is default on power up and may be changed via the configuration register. For more information about this and other features see "Interfacing to High Speed ADCs via SPI" at www.analog.com.
Table xx. SPI Timing Diagram Specifications

| Spec <br> Name | Meaning |
| :--- | :--- |
| $\mathrm{t}_{\mathrm{LS}}$ | Setup time between data and rising edge of SCLK |
| $\mathrm{t}_{\mathrm{HH}}$ | Hold time between data and rising edge of SCLK |
| $\mathrm{t}_{\mathrm{CLK}}$ | Period of the clock |
| $\mathrm{t}_{\mathrm{S}}$ | Setup time between CSB and SCLK |
| $\mathrm{t}_{\mathrm{H}}$ | Hold time between CSB and SCLK |
| $\mathrm{t}_{\mathrm{HI}}$ | Minimum period that SCLK should be in a logic high <br> state |
| $\mathrm{t}_{\mathrm{LO}}$ | Minimum period that SCLK should be in a logic low <br> state |

## HARDWARE INTERFACE

The pins described in Table xError! Reference source not found. comprise the physical interface between the user's programming device and the serial port of the AD9627. All serial pins are inputs, which should be tied to an external pullup or pull-down resistor (suggested value $10 \mathrm{k} \Omega$ ).

The SPI interface is flexible enough to be controlled by either FPGAs or mirocontrollers. This provides the user the ability use an alternate method to program the ADC other than a dedicated SPI controller.

The SPI port should not be active during periods when the full dynamic performance of the converter is required. Since the SCLK, CSB and SDIO signals are typically asynchronous to the ADC clock, noise from these signals can degrade the converter's performance. If the on board SPI Bus is utilized for other devices it may be necessary to provide buffers between this bus and the AD9627 in order to keep these signals from transitioning at the converter inputs during critical sampling periods.

Some pins serve a dual function when the SPI interface is not being used. When the pins are strapped to AVDD or ground during device power on, they are associated with a specific function. The TBD section describes the strappable functions supported on the AD9627.

## CONFIGURATION WITHOUT THE SPI

In applications that do not interface to the SPI control registers, the SDIO/DCS, SCLK/DFS, MON SDO/OEB, and MON SCLK/PDWN pins serve as stand alone CMOS compatible control pins. When the device is powered up, it is assumed that the user intends to use the pins as static control lines for the duty cycle stabilizer, output data format, output enable, and power down feature control. In this mode the CSB chip select should be connected to AVDD, which will disable the serial port interface.
Table 5. Mode Selection

| Pin | External <br> Voltage | Configuration |
| :--- | :--- | :--- |
|  | AVDD (default) | Duty Cycle Stabilizer Enabled |
|  | AGND | Duty Cycle Stabilizer Disabled |
| SCLK/DFS | AVDD | Twos Complement Enabled |
|  | AGND (default) | Offset Binary Enabled |
| MON SDO/ <br> OEB | AVDD | Outputs in High Impedance |
|  | AGND (default) | Outputs Enabled |
| MON SCLK/ <br> PDWN | AVDD | Chip in PowerDown/Standby |
|  | AGND (default) | Normal Operation |

## MEMORY MAP

## Reading the Memory Map Table

Each row in the memory map table has eight bit locations. The memory map is roughly divided into four sections: chip configuration and ID register map (Address 0x00 to Address $0 \times 05$ ), ADC setup, control and test (Addresses $0 \times 08$ to Address $0 \times 25$ ), transfer register map (Address $0 \times \mathrm{FF}$ ), and digital feature control (Address 0x100 to Address 0x11B).

Starting from the right hand column, the memory map register in Table x documents the default hex value for each hex address shown. The column with the heading Bit 7 (MSB) is the start of the default hex value given. For example, hex address 0 x18, reference select, has a hex default value of 0 xC 0 . This means Bit $7=1$, Bit $6=1$, and the remaining bits are zeros. This setting is the default reference selection setting. The default value uses a 2.0V peak to peak reference. For more information on this function and others consult "Interfacing to High Speed ADCs via SPI" at www.analog.com.

## Open Locations

All address and bit locations that are not included in Table x are currently not supported for this device. Unused bits of a valid address location should be written with 0 s. Writing to these locations is required only when part of an address location is open (for example, Address 0x18). If the entire address location is open (for example, Address 0x13), then this address location should not be written.

## Default Values

Coming out of reset, critical registers are loaded with default values. The default values for the registers are given in the

Memory Map Table.

## Logic Levels

An explanation of various registers follows: "bit is set" is synonymous with "bit is set to Logic 1" or "writing Logic 1 for the bit." Similarly "clear a bit" is synonymous with "bit is set to Logic 0 " or "writing Logic 0 for the bit."

## Transfer Register Map

Addresses 0 x 08 to 0 x 18 are shadowed. Writes to these addresses do not affect the part operation until a transfer command is issued by writing a $0 \times 01$ to address $0 \times \mathrm{xFF}$ setting the transfer bit. This allows these registers to be updated internally simultaneously when the transfer bit is set. The internal update takes place when the transfer bit is set and the bit autoclears.

## Channel Specific Registers

Some channel setup functions such as the signal monitor thresholds can be programmed differently for each channel. In these cases channel address locations are internally duplicated for each channel. These registers are designated in the 'Parameter Name' column of Table x as (local) registers. These local registers can be accessed by setting the appropriate Channel A or Channel B bits in register 0x05. If both bits are set the subsequent write will affect both channels' registers. In a read cycle only Channel A or Channel B should be set to read one of the two registers. If both bits are set during a SPI read cycle the part returns the value for channel A. Registers designated as (global) in the 'Parameter Name' column of Table x affect the entire part or the channel features where independent settings are not allowed between the channels.
The settings in register 0x05 do not affect the global registers.

## SPI ACCESSIBLE FEATURES

A brief description of all features accessible via the SPI follows. They are described in great detail in the Analog Devices user manual titled Interfacing to High Speed ADCs via SPI at www.analog.com.

Modes: Allows the user to set either power-down or standby mode.

Clock: Allows the user to access the DCS via the SPI.
Offset: Allows the user to digitally adjust the converter offset.
Test IO: Allows the user to set test modes to have known data on output bits.

Output Mode: Allows the user to setup outputs.
Output phase: Allows user to set the output clock polarity.
Output Delay: Allows user to vary the strength of the output drivers.

Vref: Allows the user to set the reference voltage.

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Figure 28. Serial Port Interface Timing Diagram

## EXTERNAL MEMORY MAP

Table 6. Memory Map Register

| Addr. <br> (Hex) | Parameter Name | $\begin{gathered} \text { Bit } 7 \\ \text { (MSB) } \end{gathered}$ | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | $\begin{aligned} & \text { Bit } 0 \\ & \text { (LSB) } \end{aligned}$ | Default Value (Hex) | Default <br> Notes/ <br> Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Chip Configuration Registers |  |  |  |  |  |  |  |  |  |  |  |
| 00 | SPI Port Configuration (global) | 0 | LSB first | Soft reset | 1 | 1 | Soft reset | LSB first | 0 | 0x18 | The nibbles should be mirrored so that LSB- or MSB-first mode registers correctly regardless of shift mode. |
| 01 | Chip ID (global) |  |  |  | $\begin{aligned} & 3 \text {-bit Ch } \\ & 9627= \end{aligned}$ | ts 7:0 (default |  |  |  | 0x0F <br> Read <br> Only | Default is unique chip ID, different for each device. This is a read-only register. |
| 02 | Chip Grade (global) | X | X | $\begin{gathered} \text { Speed Gr } \\ 11=8 \\ 10=10 \\ 01=12 \\ 00=15 \end{gathered}$ | ID 4:3 SPS SPS SPS SPS | X | X | X | X | Read only | Speed Grade ID used to differentiate devices. |
| Channel Index and Transfer Registers |  |  |  |  |  |  |  |  |  |  |  |
| 05 | Channel Index | X | X | X | X | X | X | Data Channel B (default) | Data Channel A (default) | 0x03 | Bits are set to determine which device on chip receives the next write command. Applies to local registers. |
| FF | Device Update | X | X | X | X | X | X | X | Transfer | 0x00 | Synchronously transfers data from the master shift register to the slave. |
| ADC Functions |  |  |  |  |  |  |  |  |  |  |  |
| 08 | Power modes | X | X | External Power Down Pin Function (global) $\begin{gathered} 0=\mathrm{pdwn} \\ 1=\text { stndby } \end{gathered}$ | X | X |  | $\begin{array}{r} \hline \text { Internal p } \\ \mathrm{m} \\ \text { (lc } \\ 00 \text {-norm } \\ 01 \text {-full } \\ 10-\mathrm{s} \\ \text { 11-norm } \end{array}$ | wer-down de <br> al) operation wer-down ndby operation | 0x00 | Determines various generic modes of chip operation. |
| 09 | Global clock (global) | X | X | X | X | X | X | X | Duty cycle stabilize (default) | 0x01 |  |
| OB | Clock divide (global) | X | X | X | X | X | $\begin{aligned} & \text { Clock Divid } \\ & 000=\text { divid } \\ & 001=\text { divid } \\ & 010=\text { divid } \\ & 011=\text { divid } \\ & 100=\text { divid } \\ & 101=\text { divid } \\ & 110=\text { divid } \\ & 111=\text { divid } \end{aligned}$ | Ratio <br> by 1 <br> by 2 <br> by 3 <br> by 4 <br> by 5 <br> by 6 <br> by 7 <br> by 8 |  | 0x00 | Clock divide values other than 000 automatically causes the Duty Cycle Stabilization to become active |

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| Addr. <br> (Hex) | Parameter Name | $\begin{gathered} \text { Bit } 7 \\ \text { (MSB) } \end{gathered}$ | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | $\begin{aligned} & \text { Bit } 0 \\ & \text { (LSB) } \end{aligned}$ | Default Value (Hex) | Default <br> Notes/ <br> Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0D | Test Mode (local) | X | X | Reset PN23 gen | Reset PN9 gen | X | $\begin{array}{r} 0 \\ 100-a \\ 10 \\ 111- \end{array}$ | put test m <br> —off (def <br> -midscale <br> -+positiv <br> --negati <br> nating ch <br> PN 23 seq <br> -PN 9 seq <br> e/zero wo | board ce ggle | 0x00 | When set, the test data is placed on the output pins in place of normal data. |
| OE | Bist enable (local) | X | X | X | X | X | Reset BIST Sequence | X | $\begin{gathered} \hline \text { BIST } \\ \text { Enable } \end{gathered}$ | 0x00 |  |
| 10 | Offset adjust (local) | X | X | Offset Adjust in LSBs from +31 to -32 (twos compliment format) |  |  |  |  |  | 0x00 |  |
| 14 | Output Mode | Drive Strength 0-3.3V CMOS or ANSI LVDS $1-1.8 \mathrm{~V}$ CMOS or Reduced LVDS (global) | Output Type $\begin{gathered} 0=\text { CMOS } \\ 1=\text { LVDS } \\ \text { (global) } \end{gathered}$ | Interleaved CMOS (global) | Output Enable Bar (local) | X | Output invert (local) | 00—offset binary 01— twos complement 01—greycode 11— offset binary (local) |  | 0x00 | Configures th outputs and the format of the data. |
| 15 | Output Adjust (global) | X | X | X | X | CMOS 3.3V Drive Strength (00 is lowest drive and 11 is highest drive) |  | CMOS 1.8 V Drive Strength (00 is lowest drive and 11 is highest drive) |  | 0x02 | Determines CMOS output drive strength - Selecting higher drive strengths can affect converter performance |
| 16 | Clock Phase Control (global) | Invert DCO Clock | X | X | X | X | Input clock divider phase adjust $000=$ no delay <br> $001=1$ input clock cycle <br> $010=2$ input clock cycles <br> 011 = 3 input clock cycles <br> $100=4$ input clock cycles <br> 101 = 5 input clock cycles <br> $110=6$ input clock cycles |  |  | 0x00 | On devices that utilize global clock divide, allows selection of clock delays into the dividerb. |
| 18 | Vref Select (global) | $\begin{gathered} \text { Reference Voltage } \\ \text { Selection } \\ 00=1.25 \mathrm{~V} \text { pk-pk } \\ 01=1.5 \mathrm{~V} \text { pk-pk } \\ 10=1.75 \mathrm{~V} \text { pk-pk } \\ 11=2.0 \mathrm{~V} \text { pk-pk (default) } \end{gathered}$ |  | X | X | X | X | X | X | 0x30 |  |
| 24 | BIST Signature Isb (local) | BIST Signature [7:0] |  |  |  |  |  |  |  | $0 \times 00$ | Read Only |
| 25 | BIST Signature msb (local) | BIST Signature [15:8] |  |  |  |  |  |  |  | 0x00 | Read Only |
| 100 | Synch_Control (global) | PM Sync Enable | X | X | X | X | Clock Divider Next Sync Only | Clock Divider Sync Enable |  | 0x00 |  |
| 104 | Fast Detect Control (local) | X | X | X | X | Fast Detect Mode Select [2:0] |  |  | Enable Fast Detect | 0x00 |  |
| 105 | Coarse Upper Threshold (local) | X | X | X | X | X | Coarse Upper Threshold [2:0] |  |  | 0x00 |  |


| Addr. <br> (Hex) | Parameter Name | $\begin{gathered} \text { Bit } 7 \\ \text { (MSB) } \end{gathered}$ | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | $\begin{aligned} & \text { Bit } 0 \\ & \text { (LSB) } \end{aligned}$ | Default Value (Hex) | Default Notes/ Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 106 | Fine Upper Threshold Register 0 (local) | Fine Upper Threshold [7:0] |  |  |  |  |  |  |  | 0x00 |  |
| 107 | Fine Upper <br> Threshold Register 1 (local) | X | X | X | Fine Upper Threshold [12:8] |  |  |  |  | 0x00 |  |
| 108 | Fine Lower <br> Threshold Register 0 (local) | Fine Lower Threshold [7:0] |  |  |  |  |  |  |  | 0x00 |  |
| 109 | Fine Lower <br> Threshold Register 1 (local) | X | X | X | Fine Lower Threshold [12:8] |  |  |  |  | 0x00 |  |
| 10A | Increase Gain Dwell Time Register 0 (local) | IncreaseGain Dwell Time [7:0] |  |  |  |  |  |  |  | 0x00 | In ADC Clock Cycles |
| 10B | Increase Gain Dwell Time Register 1 (local) | IncreaseGain Dwell Time [15:8] |  |  |  |  |  |  |  | 0x00 | In ADC Clock Cycles |
| 10C | Signal monitor DC Correction Control (global) | X | DC Correction Freeze | DC Correction Bandwidth [3:0] |  |  |  | DC Correction for Signal Path Enable | DC Correction for PM Enable | 0x00 |  |
| 10D | Signal monitor DC Value Channel A Register 0 (global) | DC Value Channel A [7:0] |  |  |  |  |  |  |  |  | Read only |
| 10E | Signal monitor DC Value Channel A Register 1 (global) | X | X | DC Value Channel A [13:8] |  |  |  |  |  |  | Read only |
| 10F | Signal monitor DC Value Channel B Register 0 (global) | DC Value Channel B [7:0] |  |  |  |  |  |  |  |  | Read only |
| 110 | Signal monitor DC Value Channel B Register 1 (global) |  |  | DC Value Channel A [13:8] |  |  |  |  |  |  | Read only |
| 111 | Signal monitor SPORT Control (global) | X | RMS <br> Magnitude Output Enable | Peak <br> Power Output Enable | Threshold Crossing Output Enble | $\begin{array}{r} \text { SPORT } \\ 00= \\ 01= \\ 10= \\ 11= \end{array}$ | Divide <br> ined <br> by 2 <br> by 4 <br> by 8 | SPORT <br> SCLK <br> Sleep | SPORT Enable | 0x04 |  |
| 112 | Signal monitor Control (global) | Enable Complex Power Calculation Mode | X | X | X | MS Mode $\begin{gathered} 0=\mathrm{RMS} \\ 1=\mathrm{MS} \end{gathered}$ | Signal <br> 00 <br> M <br> $01=$ <br> $1 \mathrm{x}=\mathrm{Th}$ | itor Mode <br> MS/MS <br> itude <br> k Power <br> hold Count | Signal monitor Enable | 0x00 |  |
| 113 | Signal monitor Period Register 0 (global) | Signal monitor Period [7:0] |  |  |  |  |  |  |  | 0x80 | In ADC Clock Cycles |
| 114 | Signal monitor Period Register 1 (global) | Signal monitor Period [15:8] |  |  |  |  |  |  |  | 0x00 | In ADC Clock Cycles |
| 115 | Signal monitor Period Register 2 (global) | Signal monitor Period [23:16] |  |  |  |  |  |  |  | 0x00 | In ADC Clock Cycles |
| 116 | Signal monitor | Signal monitor Value Channel A [7:0] |  |  |  |  |  |  |  |  | Read only |

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| Addr. <br> (Hex) | Parameter Name | $\begin{gathered} \text { Bit } 7 \\ \text { (MSB) } \end{gathered}$ | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | $\begin{aligned} & \text { Bit } 0 \\ & \text { (LSB) } \end{aligned}$ | Default Value (Hex) | Default Notes/ Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Value Channel A Register 0 (global) |  |  |  |  |  |  |  |  |  |  |
| 117 | Signal monitor Value Channel A Register 1 (global) | Signal monitor Value Channel A [15:8] |  |  |  |  |  |  |  |  | Read only |
| 118 | Signal monitor Value Channel A Register 2 (global) | X | X | X | X | Signal monitor Value Channel A [19:16] |  |  |  |  | Read only |
| 119 | Signal monitor Value Channel B Register 0 (global) | Signal monitor Value Channel B [7:0] |  |  |  |  |  |  |  |  | Read only |
| 11A | Signal monitor Value Channel B Register 1 (global) | Signal monitor Value Channel B [15:8] |  |  |  |  |  |  |  |  | Read only |
| 11B | Signal monitor Value Channel B Register 2 (global) | X | X | X | X | Signal monitor Value Channel B [19:16] |  |  |  |  | Read only |

## MEMORY MAP REGISTER DESCRIPTION

## APPLICATIONS

## DESIGN GUIDELINES

When designing the AD9627 into a system, it is recommended that, before starting design and layout, the designer become familiar with these guidelines, which discuss the special circuit connections and layout requirements required for certain pins.

## Power and Ground Recommendations

When connecting power to the AD9627, it is recommended that two separate 1.8 V supplies be used: one supply should be used for analog (AVDD) and digital (DVDD) and a separate supply for the digital outputs (DRVDD). The AVDD and DVDD supplies, while derived from the same source, should be isolated with a ferrite bead or filter choke and separate decoupling capacitors. The user can employ several different decoupling capacitors to cover both high and low frequencies. These should be located close to the point of entry at the PC board level and close to the part's pins with minimal trace length.

A single PC board ground plane should be sufficient when using the AD9627. With proper decoupling and smart partitioning of the PC board's analog, digital, and clock sections, optimum performance is easily achieved.

## Exposed Paddle Thermal Heat Slug Recommendations

It is mandatory that the exposed paddle on the underside of the ADC is connected to analog ground (AGND) to achieve the best electrical and thermal performance of the AD9627. A continuous exposed (no solder mask) copper plane on the PCB should mate to the AD9627 exposed paddle, Pin 0. The copper plane should have several vias to achieve the lowest possible resistive thermal path for heat dissipation to flow through the bottom of the PCB. These vias should be filled or plugged with nonconductive epoxy.

To maximize the coverage and adhesion between the ADC and PCB, overlay a silkscreen to partition the continuous plane on the PCB into several uniform sections. This provides several tie points between the two during the reflow process. Using one continuous plane with no partitions only guarantees one tie point between the ADC and PCB. See the evaluation board for a PCB layout example. For detailed information on packaging and the PCB layout of chip scale packages, see the AN-772 Application Note, "A Design and Manufacturing Guide for the Lead Frame Chip Scale Package (LFCSP)," at www.analog.com.

## CML

The CML pin should be decoupled to ground with a 0.1 uF capacitor, as shown in Figure 5.

## RBIAS

The AD9627 requires the user to place a $10 \mathrm{~K} \Omega$ resistor between the RBIAS pin and ground. This resister sets the master current reference of the ADC core and should have at least a $1 \%$ tolerance.

## Reference Decoupling

The VREF pin should be externally decoupled to ground with a low ESR 1.0 uF capacitor in parallel with a 0.1 uF ceramic low ESR capacitor.

## SPI Port

The SPI port should not be active during periods when the full dynamic performance of the converter is required. Since the SCLK, CSB and SDIO signals are typically asynchronous to the ADC clock, noise from these signals can degrade the converter's performance. If the on board SPI Bus is utilized for other devices it may be necessary to provide buffers between this bus and the AD9627 in order to keep these signals from transitioning at the converter inputs during critical sampling periods.

## AD9627 EVALUATION BOARD AND SOFTWARE

The AD9627 evaluation board kit contains a fully populated AD9627 PCB, schematic diagrams, operating software, and a comprehensive instruction manual.

Users can preview the evaluation board schematic, the software, and the instruction manual on the product Web page of the Analog Devices website.

## OUTLINE DIMENSIONS



## ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| AD9627BCPZ-150 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ] | CP-64-3 |
| AD9627BCPZ-125 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ] | CP-64-3 |
| AD9627BCPZ-105 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ] | CP-64-3 |
| AD9627BCPZ-80 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ] | CP-64-3 |
| AD9627/PCB |  | Evaluation Board with AD9627 and Software |  |


[^0]:    ${ }^{1}$ Measured with a low input frequency, full-scale sine wave, with approximately 5 pF loading on each output bit.
    ${ }^{2}$ Input capacitance refers to the effective capacitance between one differential input pin and AGND. Refer to Figure x for the equivalent analog input structure.
    ${ }^{3}$ Standby power is measured with a dc input, the CLK pins inactive (set to AVDD or AGND).

[^1]:    ${ }^{1}$ Measured with a low input frequency, full-scale sine wave, with approximately 5 pF loading on each output bit.
    ${ }^{2}$ Input capacitance refers to the effective capacitance between one differential input pin and AGND. Refer to Figure $x$ for the equivalent analog input structure.
    ${ }^{3}$ Standby power is measured with a dc input, the CLK pin inactive (set to AVDD or AGND).

[^2]:    ${ }^{1}$ With duty cycle stabilizer (DCS) enabled.
    ${ }^{2}$ With duty cycle stabilizer (DCS) disabled.
    ${ }^{3}$ Output propagation delay is measured from CLK $50 \%$ transition to DATA $50 \%$ transition, with 5 pF load.
    ${ }^{4}$ Wake-up time is dependant on the value of the decoupling capacitors.

